

AOD4182-VB Datasheet N-Channel 100-V (D-S) MOSFET

PRODU	ODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}$ (Ω)	I _D (A) ^a	Q _g (Typ.)		
100	0.0185 at V _{GS} = 10 V	45	38 nC		

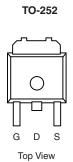
FEATURES

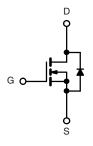
- TrenchFET® Power MOSFET
- 100 % $\rm R_{\rm g}$ and UIS Tested





- · Primary Side Switch
- Isolated DC/DC Converter





N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	100	v	
Gate-Source Voltage	V _{GS}	± 20			
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C		45 ^a		
	T _C = 100 °C		30		
	T _A = 25 °C	I _D	9.2 ^b		
	T _A = 100 °C		6.8 ^b		
Pulsed Drain Current	•	I _{DM}	140	A	
Continuous Source-Drain Diode Current	T _C = 25 °C	1	45 ^a		
	T _A = 25 °C	I _S	2 ^b		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	35		
Avalanche Energy	L = U.1 IIII	E _{AS}	101	mJ	
Maximum Power Dissipation	T _C = 25 °C		136.4	w	
	T _C = 100 °C	В	68.2		
	T _A = 25 °C	P _D	3 ^b	VV	
	T _A = 100 °C		1.5 ^b		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^b	Steady State -	R _{thJA}	40	50	°C/W
Maximum Junction-to-Case		R _{thJC}	0.85	1.1	C/VV

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Orain-Source Breakdown Voltage V _{DS}		$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100			V	
$_{DS}$ Temperature Coefficient $\Delta V_{DS}/T_J$ $_{GS(th)}$ Temperature Coefficient $\Delta V_{GS(th)}/T_J$		J 050 A		110		mV/°C	
		l _D = 250 μA		- 12.5			
Gate-Source Threshold Voltage	(-,		2.5		5	V	
Gate-Source Leakage I _{GSS}		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Vara Cata Valtaga Drain Current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V			1	μΑ	
Zero Gate Voltage Drain Current		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
Drain-Source On-State Resistance ^a R _{DS(}		$V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$		0.0185		Ω	
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 15 A		33		S	
Dynamic ^b							
Input Capacitance	C _{iss}			2400			
Output Capacitance	C _{oss}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz		230		pF	
Reverse Transfer Capacitance	C _{rss}			80]	
Total Gate Charge	Q_g			38	70	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$		14			
Gate-Drain Charge				12			
Gate Resistance R		f = 1 MHz		1.6	2.5	Ω	
Turn-On Delay Time	On Delay Time t _{d(on)}			12	20		
Rise Time	t _r	$V_{DD} = 50 \text{ V, } R_L = 1 \Omega$ $I_D \cong 50 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 1 \Omega$		10	20	ns	
Turn-Off Delay Time	t _{d(off)}			18	35		
Fall Time	t _f			8	15		
Drain-Source Body Diode Characteris	stics						
Continuous Source-Drain Diode	I _S	T _C = 25 °C			35	_	
Pulse Diode Forward Current ^a	I _{SM}	_			100	A	
Body Diode Voltage	Diode Voltage V _{SD}			0.85	1.5	V	
Body Diode Reverse Recovery Time				80	120	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			160	240	nC	
Reverse Recovery Fall Time	t _a	$I_F = 50 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		57		ns	
Reverse Recovery Rise Time	t _b			23			

Notes:

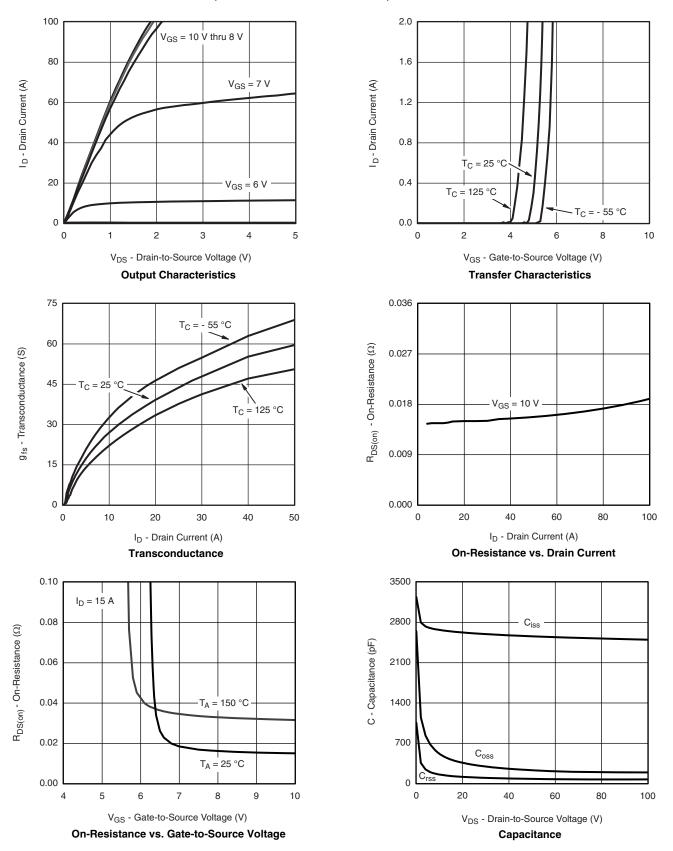
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- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

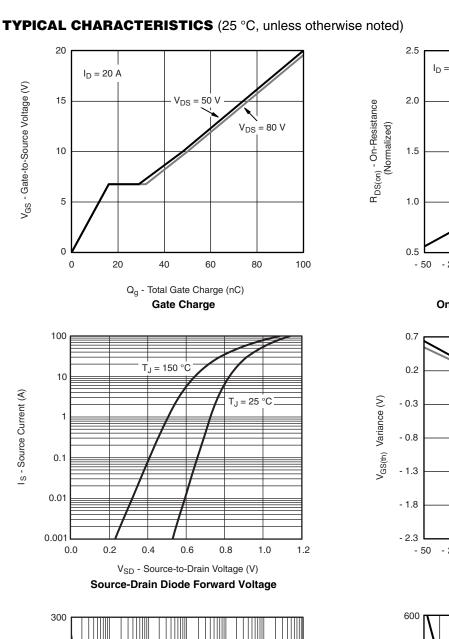


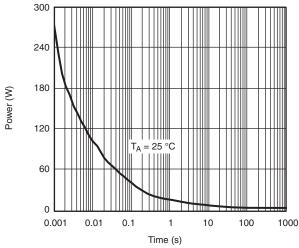
TYPICAL CHARACTERISTICS (25 °C, unless otherwise note)



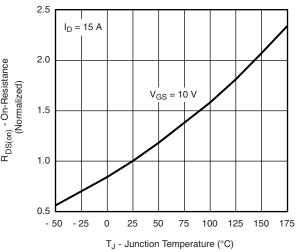
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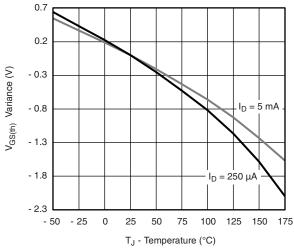




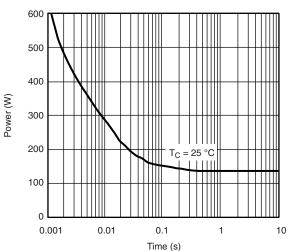
Single Pulse Power, Junction-to-Ambient



On-Resistance vs. Junction Temperature



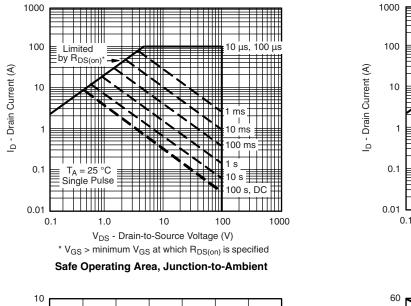
Threshold Voltage

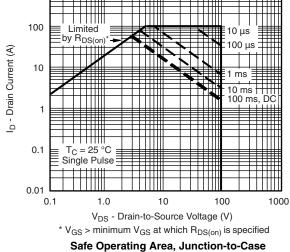


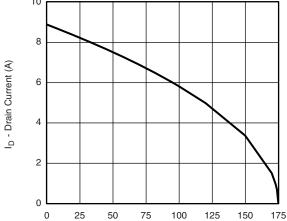
Single Pulse Power, Junction-to-Case

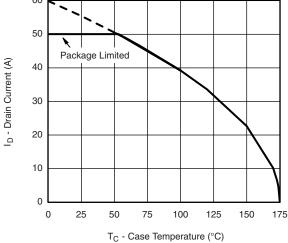


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)









T_A - Ambient Temperature (°C)

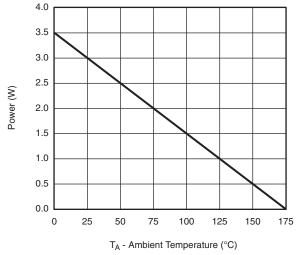
Current Derating**, Junction-to-Ambient

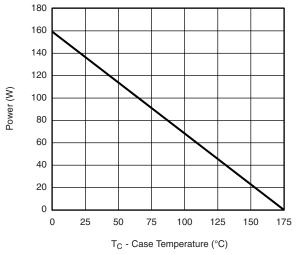
Current Derating**, Junction-to-Case

^{**} The power dissipation P_D is based on $T_{J(max.)}$ = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





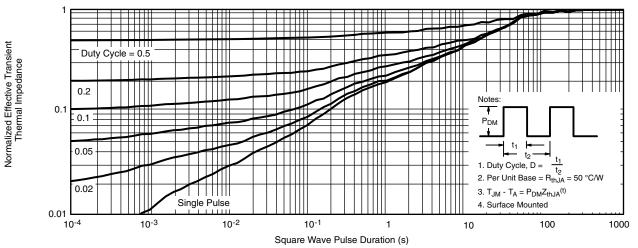
Power Derating**, Junction-to-Ambient

Power Derating**, Junction-to-Case

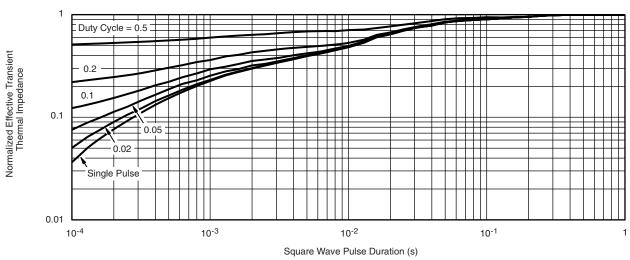
^{**} The power dissipation P_D is based on $T_{J(max)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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